



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: 09/848,932 Confirmation No.: 7101
First Named Inventor: Hoffman, Paul Filing Date: May 4, 2001
Group Art Unit: 2827 Examiner: Cruz, Lourdes C.
Atty. Docket No.: M-9954 US
Title: Shielded Semiconductor Package With Single-Sided Substrate And Method For Making The Same
Assignee: Amkor Technology, Inc.

San Francisco, California
January 13, 2003

BOX NON-FEE AMENDMENT
COMMISSIONER FOR PATENTS
Washington, D.C. 20231

**REQUEST TO AMEND DRAWINGS
UNDER 37 C.F.R. § 1.121**

Sir:

Pursuant to 37 C.F.R. § 1.121, Applicants respectfully request permission to amend Figs. 1, 5 and 6, as shown in red on the accompanying sheets.

If the Examiner has any questions concerning this request, the Examiner is invited to call the undersigned at (415) 217-6000.

EXPRESS MAIL LABEL NO:

EV 259 160 039 US

Respectfully submitted,

Robert D. Wasson
Attorney for Applicant(s)
Reg. No. 40,218
LAW OFFICES OF SKJERVEN MORRILL
Three Embarcadero Ctr., 28th Floor
San Francisco, CA 94111

LAW OFFICES OF
SKJERVEN MORRILL LLP
San Jose, CA
San Francisco, CA

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